









PRODUCT DATASHEET



- ► Ceramic High Power
- ➤ 3535 3.8t Series
- ► Cool White 5700K

N0W62S48



3535 3.8t Series





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APPLICATIONS:

- Portable Lighting
- **Outdoor Lighting**
- Commercial Lighting
- **Indoor Lighting**
- **Industrial Lighting**
- Street and Tunnel Lighting

FEATURES:

- Package: Ceramic SMT Package with Silicone Lens
- Forward Current: 350~700mA Forward Voltage (typ.): 3.2V
- Luminous Flux (typ.): 110lm@350mA
- Colour: Cool White
- Colour Temperature (CCT): 5700K
- Viewing angle: 130°
- **Materials:**
 - Die: InGaN
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- **Grouping parameters:**
 - Forward Voltage
 - Luminous Flux
 - **CIE Chromaticity**
- Soldering methods: IR Reflow Soldering
- Preconditioning: MSL 4 according to J-STD020
- Packing: 12mm tape with max.1000pcs/reel, ø180mm (7'')



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	IF	700	mA
Pulse Forward Current, D=0.01s Duty 1/10	IPF	1000	mA
Reverse Current @5V	I _R	10	μΑ
Reverse Voltage	VR	5	V
Junction Temperature	Tj	125	°C
Operating Temperature	Topr	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Soldering Temperature	Tsol	260	°C
Thermal Resistance - Junction to Solder Point	R _{th}	12	°C/W

Electrical & Optical Characteristics (Ta=25°C)

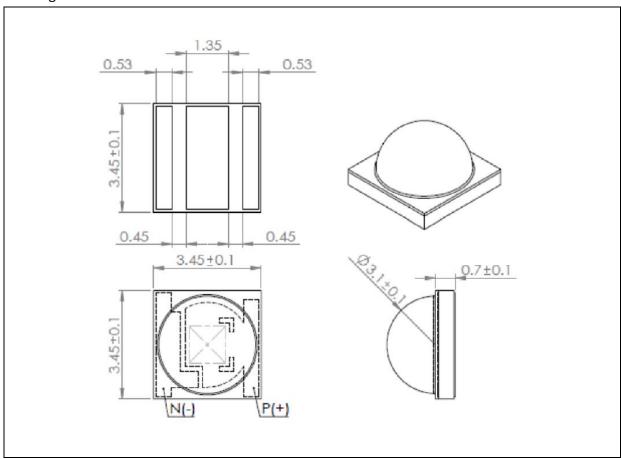
Davamatav	Compleal	Values			l lade	Test	
Parameter	Symbol	Min.	Typ. Max.		Unit	Condition	
Forward Voltage	V _F	2.8	3.2	3.6	V	I _F =350mA	
Luminous Flux	Ф۷	95		120	lm	I _F =350mA	
Chromaticity Coordinates	Х		0.3290			I _F =350mA	
	Υ		0.3417				
Colour Temperature	ССТ	5300	5700	6000	К	I _F =350mA	
Colour Rendering CRI 90 Index		95			I _F =350mA		
Viewing Angle	2θ _{1/2}		130		deg	I _F =350mA	

^{1.} Luminous flux (Φ_V) ±7%, Forward Voltage (V_F) ±0.05V, Viewing angle($2\theta_{1/2}$) ±10°



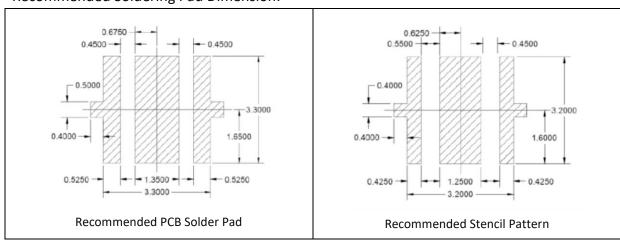
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.13mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.12mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 350mA):

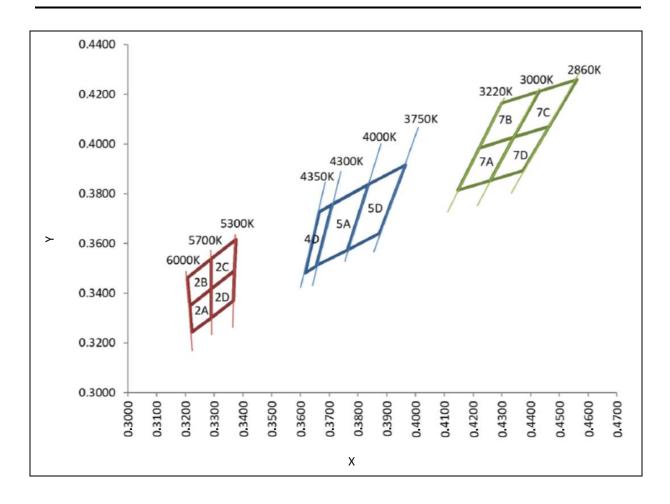
Code	Min.	Max.	Unit
V1	2.8	3.0	
V2	3.0	3.2	V
V3	3.2	3.4	V
V4	3.4	3.6	

Luminous Flux Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
LO9	90	100	
L10	100	110	lm
L11	110	120	



CIE CHROMATICITY DIAGRAM:



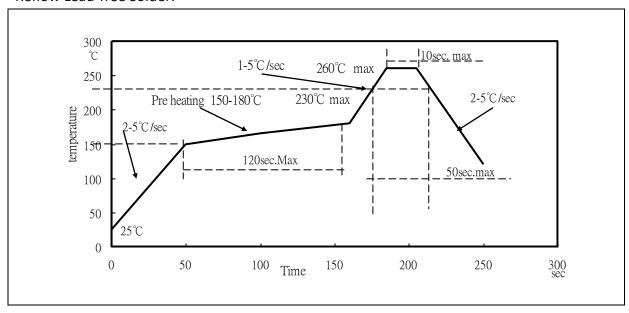
Chromaticity Coordinates Classifications (I_F = 350mA):

	1	1	2		3		4	
	Х	Y	Х	Y	Х	Υ	Х	Υ
2A	0.3215	0.3350	0.3290	0.3417	0.3290	0.3300	0.3222	0.3243
2B	0.3207	0.3462	0.3290	0.3538	0.3290	0.3417	0.3215	0.3350
2C	0.3290	0.3538	0.3376	0.3616	0.3371	0.3490	0.3290	0.3417
2D	0.3290	0.3417	0.3371	0.3490	0.3366	0.3369	0.3290	0.3300



RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



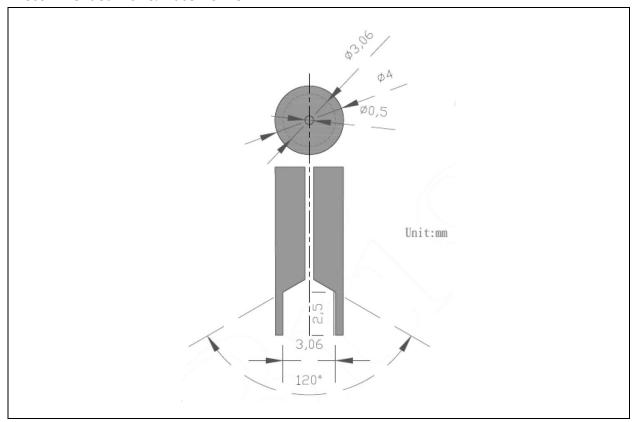
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. The recommended reflow temperature is 240°C. The maximum soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



RECOMMENDED NOZZLE FOR SMT:

Recommended Pick & Place Nozzle:

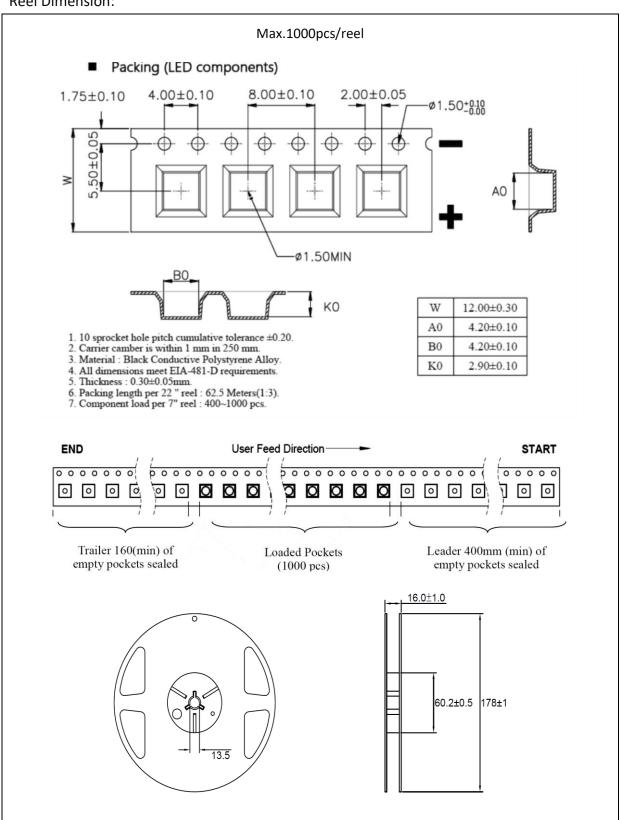


- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.
- 3. Do not apply more than 4N onto the lens.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

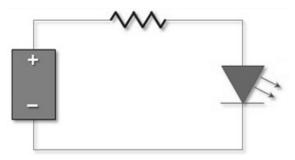
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 15hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	29/09/2022	Datasheet set-up.